

NCE N-Channel Super Trench II Power MOSFET

Description

The NCEP0230D uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

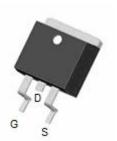
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

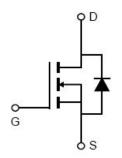
General Features

- V_{DS} =200V,I_D =30A
 R_{DS(ON)}=40mΩ (typical) @ V_{GS}=10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

TO-263





Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP0230D	NCEP0230D	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	200	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	30	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	21	Α
Pulsed Drain Current	I _{DM}	100	Α
Maximum Power Dissipation	P _D	135	W
Derating factor		0.9	W/°C
Single pulse avalanche energy (Note1)	E _{AS}	320	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	$^{\circ}$

Thermal Characteristic

Thermal Résistance, Junction-to-Case	Rejc	1.11	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

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Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	200	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =200V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	2.5	3.5	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	40	45	mΩ
Forward Transconductance	G FS	V _{DS} =5V,I _D =20A	15	-	-	S
Dynamic Characteristics						
Input Capacitance	C _{lss})/ 400\/\/ 0\/	-	1635		PF
Output Capacitance	Coss	V_{DS} =100 V , V_{GS} =0 V ,	-	128		PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHZ	-	3		PF
Switching Characteristics (Note 2)			•			,
Turn-on Delay Time	t _{d(on)}		-	7	-	nS
Turn-on Rise Time	t _r	F=1.0MHz V_{DD} =100V, R_{L} =5 Ω V_{GS} =10V, R_{G} =3 Ω V_{DS} =100V, I_{D} =20A,	-	9	-	nS
Turn-Off Delay Time	t _{d(off)}		-	25	-	nS
Turn-Off Fall Time	t _f		-	5	-	nS
Total Gate Charge	Qg	14 4001/1 004	-	25	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =100V, I_{D} =20A, V_{GS} =10V	-	10.6	-	nC
Gate-Drain Charge	Q_{gd}		-	6	-	nC
Drain-Source Diode Characteristics	,		,			
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current	Is		-	-	30	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S	-	45	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/μs	-	160	-	nC

Notes:

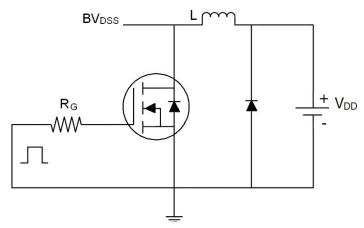
^{1.} EAS condition : Tj=25 $^{\circ}\text{C}$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25 Ω

^{2.} Guaranteed by design, not subject to production

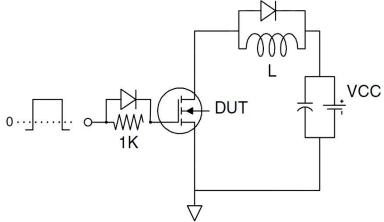
^{3.} These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.

Test Circuit

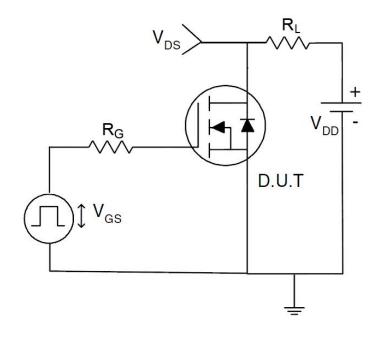
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





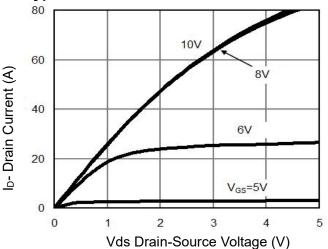


Figure 1 Output Characteristics

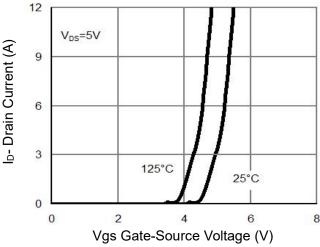


Figure 2 Transfer Characteristics

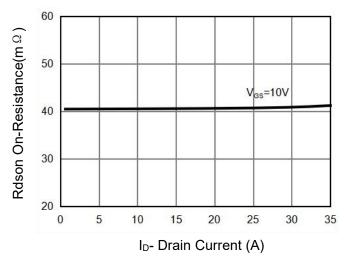


Figure 3 Rdson- Drain Current

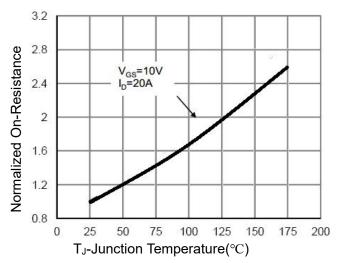


Figure 4 Rdson-Junction Temperature

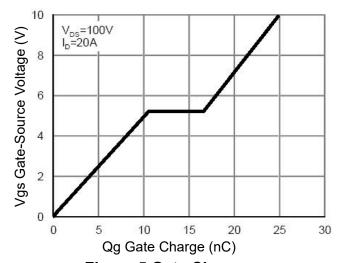


Figure 5 Gate Charge

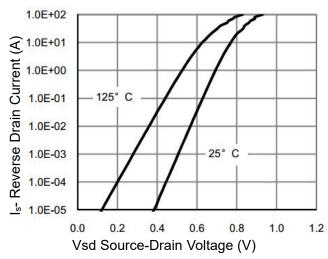
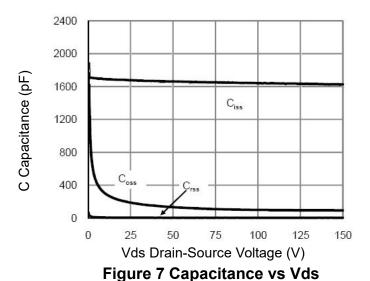
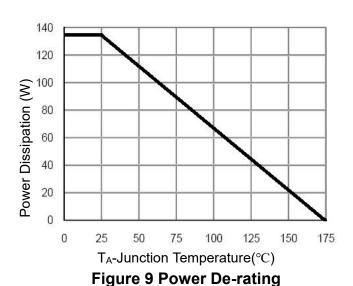


Figure 6 Source- Drain Diode Forward





100.0 10µs 100µs 10.0 Ip- Drain Current (A) 1.0 0.1 T_{J(Max)}=175° T_c=25° C 0.0 0.01 0.1 1 10 100 1000

Vds Drain-Source Voltage (V)

40

Figure 8 Safe Operation Area(Note 3)

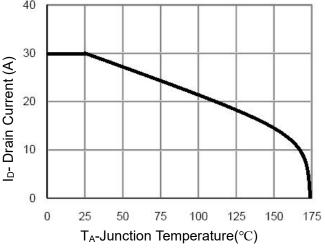
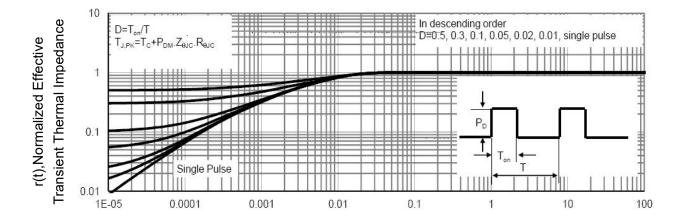


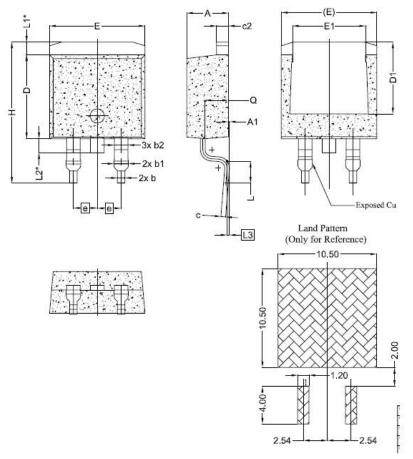
Figure 10 Current De-rating



Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

TO-263-2L Package Information



SYMBOL	DIMENSIONS			
	MIN.	NOM.	MAX.	
Α	4.24	4.44	4.64	
A1	0.00	0.10	0.25	
b	0,70	0.80	0.90 1.75 1.70	
b1	1.20	1,55		
b2	1,20	1,45		
С	0.40	0.50	0.60	
c2	1,15	1,27	1,40	
D	8.82	8.92	9.02	
D1	6.86	7.65		
E	9.96	10,16	10,36	
E1	6.89	7.77	7.89	
е		2,54 BSC		
Н	14,61	15,00	15,88	
L	1.78	2.32	2.79	
L1	1.36 REF. 1.50 REF. 0.25 BSC			
L2				
L3				
Q	2.30	2.48	2,70	

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